

### NCE N-Channel Enhancement Mode Power MOSFET

### **Description**

The NCE1102N uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### **General Features**

•  $V_{DS} = 110V, I_D = 2A$ 

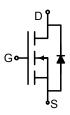
 $R_{DS(ON)}\,{<}250m\Omega\,\,\textcircled{@}\,\,V_{GS}{=}10V\quad (Typ:218m\Omega)$ 

 $R_{DS(ON)}$  <310m $\Omega$  @  $V_{GS}$ =10V (Typ:260m $\Omega$ )

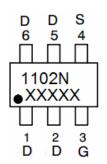
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

### **Application**

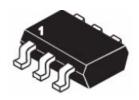
- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



### Schematic diagram



### Marking and pin assignment



SOT23-6L top view

## **Package Marking and Ordering Information**

| Device Marking | Device   | Device Package | Reel Size | Tape width | Quantity   |
|----------------|----------|----------------|-----------|------------|------------|
| 1102N          | NCE1102N | SOT23-6L       | Ø180mm    | 8 mm       | 3000 units |

## Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

| Parameter                                        | Symbol              | Limit      | Unit                   |
|--------------------------------------------------|---------------------|------------|------------------------|
| Drain-Source Voltage                             | V <sub>DS</sub>     | 110        | V                      |
| Gate-Source Voltage                              | V <sub>GS</sub>     | ±20        | V                      |
| Drain Current-Continuous                         | I <sub>D</sub>      | 2          | Α                      |
| Drain Current-Pulsed (Note 1)                    | I <sub>DM</sub>     | 5          | Α                      |
| Maximum Power Dissipation                        | P <sub>D</sub>      | 1.25       | W                      |
| Operating Junction and Storage Temperature Range | $T_{J}$ , $T_{STG}$ | -55 To 150 | $^{\circ}\!\mathbb{C}$ |

### **Thermal Characteristic**

|                                                  |                 |     | 1    |
|--------------------------------------------------|-----------------|-----|------|
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 100 | °C/W |

## **Electrical Characteristics (T<sub>A</sub>=25 ℃ unless otherwise noted)**

| Parameter                       | Symbol            | Condition                                 | Min | Тур | Max | Unit |
|---------------------------------|-------------------|-------------------------------------------|-----|-----|-----|------|
| Off Characteristics             |                   |                                           |     |     |     |      |
| Drain-Source Breakdown Voltage  | BV <sub>DSS</sub> | V <sub>GS</sub> =0V I <sub>D</sub> =250μA | 110 | -   | -   | V    |
| Zero Gate Voltage Drain Current | I <sub>DSS</sub>  | V <sub>DS</sub> =110V,V <sub>GS</sub> =0V | -   | -   | 1   | μA   |



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# **NCE1102N**

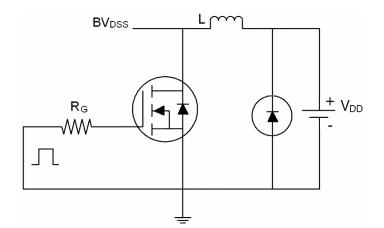
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | $V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$                                | -   | -    | ±100 | nA |
|------------------------------------|---------------------|--------------------------------------------------------------------|-----|------|------|----|
| On Characteristics (Note 3)        | •                   |                                                                    |     |      |      |    |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA            | 1.2 | 1.8  | 2.5  | V  |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =1A                           | -   | 218  | 250  | mΩ |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =4.5V, I <sub>D</sub> =1A                          | -   | 260  | 310  | mΩ |
| Forward Transconductance           | <b>g</b> FS         | V <sub>DS</sub> =5V,I <sub>D</sub> =1A                             | 1   | -    | -    | S  |
| Dynamic Characteristics (Note4)    | ·                   |                                                                    |     |      |      |    |
| Input Capacitance                  | C <sub>lss</sub>    | \/ -50\/\/ -0\/                                                    | -   | 190  | -    | PF |
| Output Capacitance                 | Coss                | $V_{DS}$ =50V, $V_{GS}$ =0V,<br>F=1.0MHz                           | -   | 22   | -    | PF |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    | F-1.UIVIFIZ                                                        | -   | 13   | -    | PF |
| Switching Characteristics (Note 4) | ·                   |                                                                    |     |      |      |    |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  |                                                                    | -   | 6    | -    | nS |
| Turn-on Rise Time                  | t <sub>r</sub>      | $V_{DD}$ =50V, $I_{D}$ =1.3A, $R_{L}$ =39 $\Omega$                 | -   | 10   | -    | nS |
| Turn-Off Delay Time                | t <sub>d(off)</sub> | $V_{GS}$ =10 $V$ , $R_{G}$ =1 $\Omega$                             | -   | 10   | -    | nS |
| Turn-Off Fall Time                 | t <sub>f</sub>      |                                                                    | -   | 6    | -    | nS |
| Total Gate Charge                  | $Q_g$               | V <sub>DS</sub> =50V,I <sub>D</sub> =1.3A,<br>V <sub>GS</sub> =10V | -   | 5.2  |      | nC |
| Gate-Source Charge                 | $Q_{gs}$            |                                                                    | -   | 0.75 | -    | nC |
| Gate-Drain Charge                  | $Q_{gd}$            | V <sub>GS</sub> -10V                                               | -   | 1.4  | -    | nC |
| Drain-Source Diode Characteristics | •                   |                                                                    |     |      |      |    |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V,I <sub>S</sub> =1.3A                           | -   | -    | 1.2  | V  |
| Diode Forward Current (Note 2)     | Is                  |                                                                    | -   | -    | 2    | Α  |
|                                    |                     |                                                                    |     |      |      |    |

### Notes:

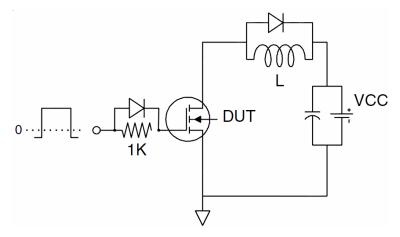
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

# **Test Circuit**

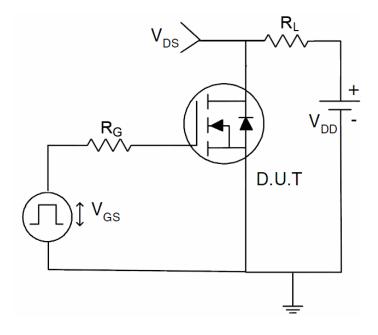
# 1) E<sub>AS</sub> test circuit



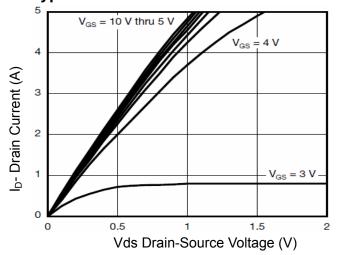
## 2) Gate charge test circuit



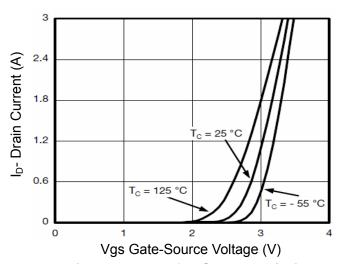
## 3) Switch Time Test Circuit



# Typical Electrical and Thermal Characteristics (Curves)



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

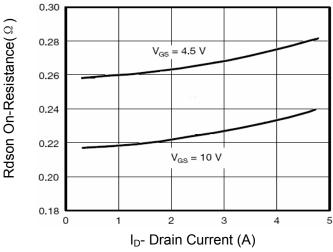


Figure 3 Rdson- Drain Current

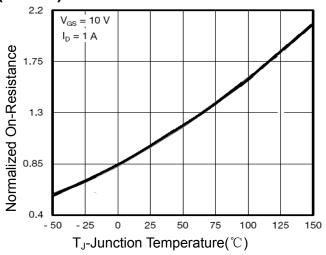


Figure 4 Rdson-JunctionTemperature

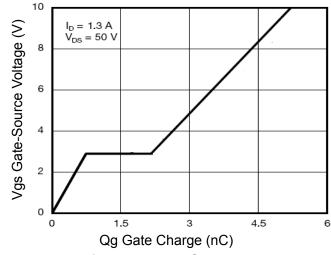


Figure 5 Gate Charge

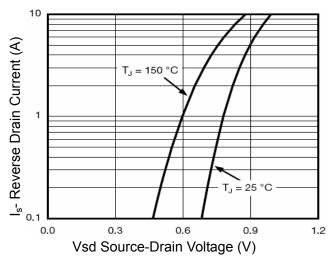
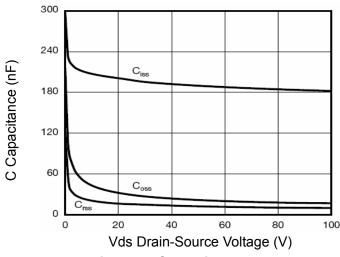


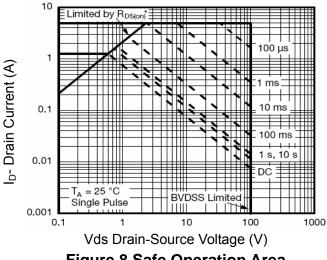
Figure 6 Source- Drain Diode Forward

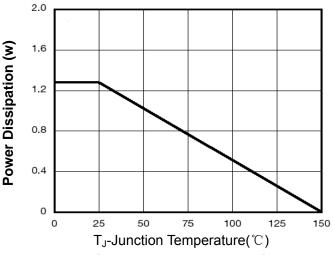


 $BV_{DSS}$ V<sub>GS</sub>=0 (norm) l<sub>D</sub>=250μA 1.2 1.1 1.0 0.9 0.8 150 TJ(°C) T<sub>J</sub>-Junction Temperature(°C)

Figure 7 Capacitance vs Vds

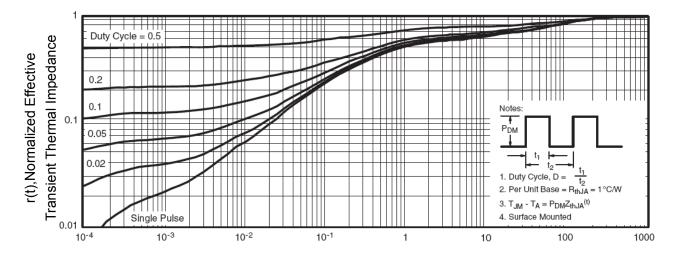
Figure 9 BV<sub>DSS</sub> vs Junction Temperature





**Figure 8 Safe Operation Area** 

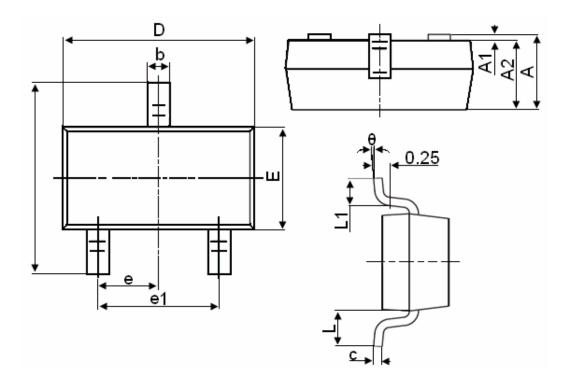
Figure 10 Power De-ratin



Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

# **SOT-23 Package Information**



| Symbol | Dimensions in Millimeters |          |  |  |  |
|--------|---------------------------|----------|--|--|--|
| Symbol | MIN.                      | MAX.     |  |  |  |
| А      | 0.900                     | 1.150    |  |  |  |
| A1     | 0.000                     | 0.100    |  |  |  |
| A2     | 0.900                     | 1.050    |  |  |  |
| b      | 0.300                     | 0.500    |  |  |  |
| С      | 0.080                     | 0.150    |  |  |  |
| D      | 2.800                     | 3.000    |  |  |  |
| Е      | 1.200                     | 1.400    |  |  |  |
| E1     | 2.250                     | 2.550    |  |  |  |
| е      |                           | 0.950TYP |  |  |  |
| e1     | 1.800                     | 2.000    |  |  |  |
| L      |                           | 0.550REF |  |  |  |
| L1     | 0.300                     | 0.500    |  |  |  |
| θ      | 0°                        | 8°       |  |  |  |

### Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance  $\pm 0.10$ mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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